

REMARKS

The amendment to the title of the application is intended to make it clear that the title should be the original title "Semiconductor Packages and Methods for Making the Same." In an examiner's amendment mailed on June 18, 2003, the title was amended to read "Semiconductor Package Having Defective Substrate." However, applicants want to retain the original title. Moreover, the most recent Notice of Allowance and PAIR both indicate that the title is the original title "Semiconductor Packages and Methods for Making the Same." The present amendment ensures that the pending title is, in fact, the original title "Semiconductor Packages and Methods for Making the Same."

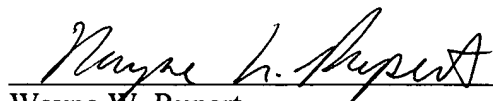
Claims 1-29 and 33-35 were previously canceled. Claims 30-32 and 36-40 have been amended for purposes not related to patentability. New claims 41-47 have been added. Support for claims 41 and 46 is found in the specification, for example, at page 9, lines 3-8. Support for claims 42 and 47 is found in the specification, for example, at page 7, lines 1-4 and FIGS. 3A and 3B. Support for claim 43 is found throughout the specification. Support for claim 44 is found in the specification, for example, at page 5, lines 12-19. New claim 45 tracks previously presented claim 37. Entry of these amendments is respectfully requested. Claims 30-32 and 36-47 will be pending.

It is respectfully submitted that the claims are in condition for allowance. Should there be any questions regarding this application, Examiner Zarneke is invited to contact the undersigned attorney at the telephone number shown below.

Respectfully submitted,

KLARQUIST SPARKMAN, LLP

By


Wayne W. Rupert
Registration No. 34,420

One World Trade Center, Suite 1600
121 S.W. Salmon Street
Portland, Oregon 97204
Telephone: (503) 226-7391
Facsimile: (503) 228-9446